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FIRST NAMED INVENTOR ATTORNEY DOCKET NO. CONFIRMATION NO. APPLICATION NO. FILING DATE 09/671,538 09/27/2000 Jyoti Mazumder POM-11902/29 6711 **EXAMINER** 12/23/2003 John G. Posa, Esq. RAPP, CHAD GIFFORD, KRASS, GROH, SPRINKLE, PAPER NUMBER ART UNIT ANDERSON & CITKOWSKI, P.C., 280 N. Old Woodward Ave., Suite 400 2125 Birmingham, MI 48009 DATE MAILED: 12/23/2003

Please find below and/or attached an Office communication concerning this application or proceeding.

Q.	Application No.	Applicant(s)
Office Action Summary	09/671,538	MAZUMDER ET AL.
	Examiner	Art Unit
	Chad Rapp	2125
The MAILING DATE of this communication ap Period for Reply	pears on the cover sheet with	the correspondence address
A SHORTENED STATUTORY PERIOD FOR REPL THE MAILING DATE OF THIS COMMUNICATION.  - Extensions of time may be available under the provisions of 37 CFR 1. after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a rep If NO period for reply is specified above, the maximum statutory period Failure to reply within the set or extended period for reply will, by statut - Any reply received by the Office later than three months after the mailin earned patent term adjustment. See 37 CFR 1.704(b).  Status	136(a). In no event, however, may a reply oly within the statutory minimum of thirty (3) will apply and will expire SIX (6) MONTHS ie, cause the application to become ABANI	be timely filed  0) days will be considered timely.  5 from the mailing date of this communication.  DONED (35 U.S.C. § 133).
1) Responsive to communication(s) filed on 27 S	September 2000.	
2a) ☐ This action is <b>FINAL</b> . 2b) ☑ This	action is non-final.	
Since this application is in condition for allowated closed in accordance with the practice under the second condition.		
Disposition of Claims		
4) ☐ Claim(s) 1-20 is/are pending in the application 4a) Of the above claim(s) is/are withdra 5) ☐ Claim(s) is/are allowed. 6) ☐ Claim(s) 1-20 is/are rejected. 7) ☐ Claim(s) is/are objected to. 8) ☐ Claim(s) are subject to restriction and/o	awn from consideration.	
Application Papers	or election requirement.	•
· · ·		
9)☑ The specification is objected to by the Examine 10)☐ The drawing(s) filed on is/are: a)☐ acc		the Evaminer
Applicant may not request that any objection to the	•	
Replacement drawing sheet(s) including the correct		
11) The oath or declaration is objected to by the E		
Priority under 35 U.S.C. §§ 119 and 120		
a) Acknowledgment is made of a claim for foreig a) All b) Some * c) None of:  1. Certified copies of the priority document 2. Certified copies of the priority document 3. Copies of the certified copies of the priority application from the International Burea * See the attached detailed Office action for a list 13) Acknowledgment is made of a claim for domest since a specific reference was included in the firm 37 CFR 1.78. a) ☐ The translation of the foreign language pro 14) Acknowledgment is made of a claim for domest reference was included in the first sentence of the	ts have been received. ts have been received in Appl ority documents have been received (PCT Rule 17.2(a)). t of the certified copies not receive priority under 35 U.S.C. § 1 rst sentence of the specification ovisional application has been tic priority under 35 U.S.C. §§	ication No ceived in this National Stage reived. 19(e) (to a provisional application) on or in an Application Data Sheet. 120 and/or 121 since a specific
Attachment(s)		
Notice of References Cited (PTO-892)  Notice of Draftsperson's Patent Drawing Review (PTO-948)  Notice of Draftsperson's Patent Drawing Review (PTO-948)  Information Disclosure Statement(s) (PTO-1449) Paper No(s)	5) Notice of Inform	mary (PTO-413) Paper No(s) mal Patent Application (PTO-152)

1. Claims 1-20 are presented for examination.

### Specification

- 2. The abstract of the disclosure is objected to because it contains too many words(must be less than or equal to 150 words). Correction is required. See MPEP § 608.01(b).
- 3. The disclosure is objected to because of the following informalities:

The section titled "Reference to related applications" needs to be updated because some of the applications have become patents.

Appropriate correction is required.

## Claim Rejections - 35 USC § 103

- 4. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 5. Claims 1-2 and 5-8 are rejected under 35 U.S.C. 103(a) as being unpatentable over Coronel et al. in view of McCay et al.

Coronel et al. teaches the claimed invention (claim1) substantially as claimed including a method of optimizing a laser –assisted direct metal deposition process wherein material added to a melt pool is solidified to fabricate an object according to a description thereof comprising:

a. Creating a database including acceptable direct metal deposition process parameters based upon previously obtained empirical data is taught as a database that contains

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process parameters in normal operating conditions and it contains the history of the wafer(abstract);

- b. Referring to the deposition of the object to determine if the object is being fabricated in accordance with the description and if so is taught as pre and post processing measurement to determine if the wafer is still within specifications at each output of chamber(col. 2 lines 39-49);
- c. Referring to the database to determine if the process parameters are within acceptable limits and if not is taught as analysis rules are developed to perform a comparison and associated rejection criteria are coded in the form of algorithms which are stored in a database(col. 1 lines 10-20);
- d. Implementing a corrective action is taught as an adequate action is immediately taken(col. 1 lines 10-20).

Coronel et al. teaches the above listed details of the independent claim 1, however,

Coronel et al. does not teach: measuring one or more dimensions of the melt pool and

monitoring the accumulation of residual stress of the object.

#### McCay et al. teaches:

- a. Monitoring the accumulation of residual stress of the object is taught as an acoustic work piece which detects the work piece internal stress waves(col. 1 lines 28-30);
- b. Measuring one or more dimensions of the melt pool is taught as video imaging of the laser/surface interaction region(col. 13 line 11-13).

It would have been obvious to one of ordinary skill at the time the invention was made or used to modify the teachings of Coronel et al. with the teachings of McCay et al. because both

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patents contain the monitoring of process parameters to be used as feedback to keep the system running within acceptable limits. Coronel et al. speaks of some of the key parameters such as gas flows, pressure, temperature and RF powers. McCay et al. brings in additional key parameters, stress and melt pool dimensions. The more key process parameters that are measured the more the system can improve the design and bring the design into tight tolerances.

As to claim 2, McCay et al. teaches wherein the process parameter is the accumulation of stress within the object is taught as an acoustic work piece which detects the work piece internal stress waves(col. 1 lines 28-30).

It would have been obvious to one of ordinary skill at the time the invention was made or used to modify the teachings of Coronel et al. with the teachings of McCay et al. because both patents contain the monitoring of process parameters to be used as feedback to keep the system running within acceptable limits. Coronel et al. speaks of some of the key parameters such as gas flows, pressure, temperature and RF powers. McCay et al. brings in additional key parameters, stress dimensions. The more key process parameters that are measured the more the system can improve the design and bring the design into tight tolerances.

As to claim 5, McCay et al. teaches wherein the corrective measure is to modify the speed of the deposition is taught as the controller communicates with the movement system for purposes of regulating relative movement between the delivery system and the work piece such as rate of speed and direction(col. 8 lines 23-27).

It would have been obvious to one of ordinary skill at the time the invention was made or used to modify the teachings of Coronel et al. with the teachings of McCay et al. because another parameter that needs to be measure and kept in normal limits is the rate of the deposition

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speed. Things that affect this measure are the movement of the delivery system which has the application unit connected. The controller regulates the delivery system with the application unit to speed up or slow down do to the feedback signals.

As to claim 6, McCay et al. teaches wherein the residual stress of the object is monitored through sub-harmonic vibration is taught as an acoustic work piece which detects the work piece internal stress waves(col. 1 lines 28-30).

It would have been obvious to one of ordinary skill at the time the invention was made or used to modify the teachings of Coronel et al. with the teachings of McCay et al. It would have been obvious to one of ordinary skill at the time the invention was made or used to modify the teachings of Coronel et al. with the teachings of McCay et al. because both patents contain the monitoring of process parameters to be used as feedback to keep the system running within acceptable limits. Coronel et al. speaks of some of the key parameters such as gas flows, pressure, temperature and RF powers. McCay et al. brings in additional key parameters, stress dimensions. The more key process parameters that are measured the more the system can improve the design and bring the design into tight tolerances.

As to claim 7, McCay et al. teaches wherein the process parameter is the temperature of the melt pool is taught as temperature measurements can be used to provide feedback fro purposes of modifying the operating parameters of the laser. The process can use pyrometric temperature measurement of the surface of the work piece near the laser/surface interaction region(col. 12 line 65 to col. 13 line 19).

It would have been obvious to one of ordinary skill at the time the invention was made or used to modify the teachings of Coronel et al. with the teachings of McCay et al. It would have

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been obvious to one of ordinary skill at the time the invention was made or used to modify the teachings of Coronel et al. with the teachings of McCay et al. because both patents contain the monitoring of process parameters to be used as feedback to keep the system running within acceptable limits. Coronel et al. speaks of some of the key parameters such as gas flows, pressure, temperature and RF powers. McCay et al. brings in the monitoring and feedback of the key parameters temperature. This feed back and motoring of the temperature makes the design have tight tolerances.

As to claim 8,McCay et al. teaches wherein the corrective measure is to modify the power delivered to the laser is taught as temperature measurements can be used to provide feedback for purposes of modifying the operating parameters of the laser; primarily the power of the laser beam(col. 12 line 65 to col. 13 line 19).

It would have been obvious to one of ordinary skill at the time the invention was made or used to modify the teachings of Coronel et al. with the teachings of McCay et al. because the feedback of the monitored temperature allows the controller of the system to change the power of the laser to keep the design operating at normal conditions.

6. Claim 3 is rejected under 35 U.S.C. 103(a) as being unpatentable over Coronel et al. in view of McCay et al. and further in view of Lewis et al.

Coronel et al. teaches the claimed invention (claim1) see paragraph number 5 above.

As to claim 3, Lewis et al. teaches wherein the corrective measure is modify the contour path of the laser is taught as tool path adjustments can be made to affect heat flow(col. 23 lines 44-45).

It would have been obvious to one of ordinary skill at the time the invention was made or used to modify the teachings of Coronel et al. with the teachings of Lewis et al. because the patents deal with control signals to adjust the apparatus functions. One apparatus adjustment is a tool path adjustment affecting the temperature parameter of heat flow; allowing the adjustment of the path of the laser brings the heat flow back in to normal condition parameters.

7. Claim 4 is rejected under 35 U.S.C. 103(a) as being unpatentable over Coronel et al. in view of McCay et al. and further in view of Jeantette et al.

Coronel et al. teaches the claimed invention (claim1) see paragraph number 5 above.

As to claim 4, Jeantette et al. teaches wherein the corrective measure is to modify the mass flow of the powder is taught as the powder flow sensor measures the flow of powdered material to the delivery system and produce either a relative mass-flow signal or a calibrated mass-flow signal for a particular powered material. The sensor also provides a means of measuring pulsations or variations in the flow pattern and provides a method to indicate if unstable operating conditions are present.

It would have been obvious to one of ordinary skill at the time the invention was made or used to modify the teachings of Coronel et al. with the teachings of Jeantette et al. because both patents comprise a feedback loop control. When low frequency variations in the powder stream are detected t signal is provided to the mass powder flow control. The various sensor can be also used individually to provide an error signal to make the process more robust.

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8. Claim 9 is rejected under 35 U.S.C. 103(a) as being unpatentable over Coronel et al. in view of McCay et al. and further in view of Duley et al.

Coronel et al. teaches the claimed invention (claim1) see paragraph number 5 above.

As to claim 9, Duley et al. teaches wherein one or more dimensions of the melt pool are measured by monitoring the light received at the pixels of an optical detector is taught as a visible light detector to detect light from a laser material interaction zone. It determines the number of bright pixels above a pre-defined number which effectively gives the spatial exterior area of the visible light emitted from an interaction zone(abstract).

It would have been obvious to one of ordinary skill at the time the invention was made or used to modify the teachings of Coronel et al. with the teachings of Duley et al. because both patents deal with controlling process variables in a laser processing system. One the process parameters measured by the Duley et al. invention is the dimensions of a melt pool. The Duley et al. invention brings in the ability to monitor the variables in real time.

9. Claim 10 is rejected under 35 U.S.C. 103(a) as being unpatentable over Coronel et al. in view of McCay et al. and further in view of Watkins.

Coronel et al. teaches the claimed invention (claim1) see paragraph number 5 above.

As to claim 10, Watkins teaches wherein the database includes look-up table is taught as a database lookup table(col. 7 lines 11-17).

It would have been obvious to one of ordinary skill at the time the invention was made or used to modify the teachings of Coronel et al. with the teachings of Watkins because the Watkins

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patent describes process control and it establishes baseline values through a plurality or runs and analysis.

### Claim Rejections - 35 USC § 103

- 10. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 11. Claims 11-12 and 15-18 are rejected under 35 U.S.C. 103(a) as being unpatentable over Coronel et al. in view of McCay et al.

Coronel et al. teaches the claimed invention (claim 11) substantially as claimed including a system for optimizing a laser-assisted direct metal deposition process wherein an object fabricated in accordance with a description thereof the system comprising;

- a. A database including acceptable direct metal deposition process parameters based upon previously obtained empirical data is taught as a database that contains process parameters in normal operating conditions and it contains the history of the wafer(abstract);
- b. Refer to the description of the object to determine if the object is being fabricated in accordance with the description and if so is taught as pre and post processing measurement to determine if the wafer is still within specifications at each output of chamber(col. 2 lines 39-49);

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c. Refer to the database to determine if the process parameters are within acceptable limits if not is taught as analysis rules are developed to perform a comparison and associated rejection criteria are coded in the form of algorithms which are stored in a database(col. 1 lines 10-20);

d. Implement a corrective action is taught as an adequate action is immediately taken(col. 1 lines 10-20).

Coronel et al. teaches the above listed details of the independent claim 1, however,

Coronel et al. does not teach: a controllably movable deposition head including a laser operative
to form a melt pool on the surface of the object and a supply of powder feeding the melt pool to
be solidified as the deposition head is traversed, a first sensor for detecting one or more
dimensions of the melt pool, a second sensor the sensing the accumulation of residual stress of
the object and a controller interfaced to the laser, deposition head movement control, database
and first and second sensors, the controller being operative to perform the following functions

McCay et al. teaches:

- a. A controllably movable deposition head including a laser operative to form a melt pool on the surface of the object and a supply of powder feeding the melt pool to be solidified as the deposition head is traversed is taught as laser, interaction zone(melt pool), application unit(deliveries powder to work piece) and the delivery system moves the application unit(col. 7 lines 34, col. 7 lines 65-37 and col. 13 line 10);
- b. A first sensor for detecting one or more dimensions of the melt pool is taught as video imaging of the laser/surface interaction region(col. 13 line 11-13);

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c. A second sensor the sensing the accumulation of residual stress of the object is taught as an acoustic work piece which detects the work piece internal stress waves(col. 1 lines 28-30);

d. A controller interfaced to the laser, deposition head movement control, database and first and second sensors, the controller being operative to perform the following functions is taunt as a laser, application unit connected to the delivery system, the first (video imaging) and second sensor (acoustic signals) signals are sent (feedback information) to the controller (col. 7 lines 34, col. 7 lines 65-37 and col. 12 line 65 to col. 13 line 44).

It would have been obvious to one of ordinary skill at the time the invention was made or used to modify the teachings of Coronel et al. with the teachings of McCay et al. because both patents contain the monitoring of process parameters to be used as feedback to keep the system running within acceptable limits. Coronel et al. speaks of some of the key parameters such as gas flows, pressure, temperature and RF powers. McCay et al. brings in additional key parameters, stress and melt pool dimensions. The more key process parameters that are measured the more the system can improve the design and bring the design into tight tolerances.

As to claim 12, McCay et al. teaches wherein the process parameter is the accumulation of stress within the object is taught as an acoustic work piece which detects the work piece internal stress waves(col. 1 lines 28-30).

It would have been obvious to one of ordinary skill at the time the invention was made or used to modify the teachings of Coronel et al. with the teachings of McCay et al. because both patents contain the monitoring of process parameters to be used as feedback to keep the system running within acceptable limits. Coronel et al. speaks of some of the key parameters such as

gas flows, pressure, temperature and RF powers. McCay et al. brings in additional key parameters, stress dimensions. The more key process parameters that are measured the more the system can improve the design and bring the design into tight tolerances.

As to claim 15, McCay et al. teaches wherein the corrective measure is to modify the speed of the deposition is taught as the controller communicates with the movement system for purposes of regulating relative movement between the delivery system and the work piece such as rate of speed and direction(col. 8 lines 23-27).

It would have been obvious to one of ordinary skill at the time the invention was made or used to modify the teachings of Coronel et al. with the teachings of McCay et al. because another parameter that needs to be measure and kept in normal limits is the rate of the deposition speed. Things that affect this measure are the movement of the delivery system which has the application unit connected. The controller regulates the delivery system with the application unit to speed up or slow down do to the feedback signals.

As to claim 16, McCay et al. teaches wherein the residual stress of the object is monitored through sub-harmonic vibration is taught as an acoustic work piece which detects the work piece internal stress waves(col. 1 lines 28-30).

It would have been obvious to one of ordinary skill at the time the invention was made or used to modify the teachings of Coronel et al. with the teachings of McCay et al. It would have been obvious to one of ordinary skill at the time the invention was made or used to modify the teachings of Coronel et al. with the teachings of McCay et al. because both patents contain the monitoring of process parameters to be used as feedback to keep the system running within acceptable limits. Coronel et al. speaks of some of the key parameters such as gas flows,

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pressure, temperature and RF powers. McCay et al. brings in additional key parameters, stress dimensions. The more key process parameters that are measured the more the system can improve the design and bring the design into tight tolerances.

As to claim 17, McCay et al. teaches wherein temperature sensors taught as pyrometric temperature(col. 12 line 65 to col. 13 line 19).

It would have been obvious to one of ordinary skill at the time the invention was made or used to modify the teachings of Coronel et al. with the teachings of McCay et al. It would have been obvious to one of ordinary skill at the time the invention was made or used to modify the teachings of Coronel et al. with the teachings of McCay et al. because both patents contain the monitoring of process parameters to be used as feedback to keep the system running within acceptable limits. Coronel et al. speaks of some of the key parameters such as gas flows, pressure, temperature and RF powers. McCay et al. brings in the monitoring and feedback of the key parameters temperature. This feed back and motoring of the temperature makes the design have tight tolerances.

As to claim 18,McCay et al. teaches wherein the corrective measure is to modify the power delivered to the laser is taught as temperature measurements can be used to provide feedback for purposes of modifying the operating parameters of the laser; primarily the power of the laser beam(col. 12 line 65 to col. 13 line 19).

It would have been obvious to one of ordinary skill at the time the invention was made or used to modify the teachings of Coronel et al. with the teachings of McCay et al. because the feedback of the monitored temperature allows the controller of the system to change the power of the laser to keep the design operating at normal conditions.

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12. Claim 13 is rejected under 35 U.S.C. 103(a) as being unpatentable over Coronel et al. in view of McCay et al. and further in view of Lewis et al.

Coronel et al. teaches the claimed invention (claim11) see paragraph number 12 above

As to claim 13, Lewis et al. teaches wherein the corrective measure is modify the contour

path of the laser is taught as tool path adjustments can be made to affect heat flow(col. 23 lines

44-45).

It would have been obvious to one of ordinary skill at the time the invention was made or used to modify the teachings of Coronel et al. with the teachings of Lewis et al. because the patents deal with control signals to adjust the apparatus functions. One apparatus adjustment is a tool path adjustment affecting the temperature parameter of heat flow; allowing the adjustment of the path of the laser brings the heat flow back in to normal condition parameters.

13. Claims 14 and 20 are rejected under 35 U.S.C. 103(a) as being unpatentable over Coronel et al. in view of McCay et al. and further in view of Jeantette et al.

Coronel et al. teaches the claimed invention (claim 11) see paragraph number 12 above.

As to claim 14, Jeantette et al. teaches wherein the corrective measure is to modify the mass flow of the powder is taught as the powder flow sensor measures the flow of powdered material to the delivery system and produce either a relative mass-flow signal or a calibrated mass-flow signal for a particular powered material. The sensor also provides a means of measuring pulsations or variations in the flow pattern and provides a method to indicate if unstable operating conditions are present.

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It would have been obvious to one of ordinary skill at the time the invention was made or used to modify the teachings of Coronel et al. with the teachings of Jeantette et al. because both patents comprise a feedback loop control. When low frequency variations in the powder stream are detected t signal is provided to the mass powder flow control. The various sensor can be also used individually to provide an error signal to make the process more robust.

As to claim 20, Jeantette et al. teaches that including multiple deposition heads is taught as four jets(col. 7 line 23).

It would have been obvious to one of ordinary skill at the time the invention was made or used to modify the teachings of Coronel et al. with the teachings of Jeantette et al. because the multiple heads allows functionally graded or dissimilar composition structures to be fabricated directly from CAD solid model; which makes the system versatile.

14. Claim 19 is rejected under 35 U.S.C. 103(a) as being unpatentable over Coronel et al. in view of McCay et al. and further in view of Duley et al.

Coronel et al. teaches the claimed invention (claim11) see paragraph number 12 above.

As to claim 19, Duley et al. teaches wherein the second sensor is a one or twodimensional pixelized image sensor is taught as a visible light detector to detect light from a laser material interaction zone. It determines the number of bright pixels above a pre-defined number which effectively gives the spatial exterior area of the visible light emitted from an interaction zone(abstract).

It would have been obvious to one of ordinary skill at the time the invention was made or used to modify the teachings of Coronel et al. with the teachings of Duley et al. because both

patents deal with controlling process variables in a laser processing system. One the process parameters measured by the Duley et al. invention is the dimensions of a melt pool. The Duley et al. invention brings in the ability to monitor the variables in real time.

#### Conclusion

15. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Chad Rapp whose telephone number is (703)306-4528. The examiner can normally be reached on Mon-Fri 11:00-7:00.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Leo Picard can be reached on (703)308-0538. The fax phone number for the organization where this application or proceeding is assigned is (703)746-7239.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703)305-9600.

Chad Rapp Examiner

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cjr

LEO PICARD SUPERVISORY PATENT EXAMINER TECHNOLOGY CENTER 2100

LP.P